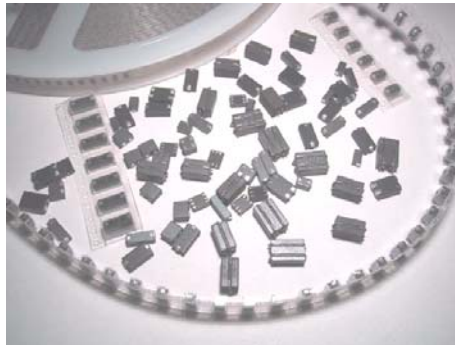


Lead-Free Terminations & RoHS Compliance



Materials Declaration for RoHS Compliance

This declaration is to certify that all standard components manufactured by Fair-Rite Products Corp. listed in the 15th Edition Catalog meet the requirements of the current RoHS Directive 2002/95/EC as of January 1, 2005.

Fair-Rite's core business is the manufacture of soft ferrite components. The composition of the soft ferrite material is characterized by metal oxides. Soft ferrite material that Fair-Rite Products Corp. supplies has always been RoHS Compliant. All soft ferrite components manufactured by Fair-Rite Products Corp. have a Moisture Sensitivity Level of 1.

Fair-Rite Products Corp. supplies all standard components as RoHS compliant. Plastic cases used to assemble Fair-Rite "Snap-It" cable bead assemblies do not contain PBB or PBDE as a flame retardant substance. The termination wire used on board level components has a Pb-Free, 100% matte tin plated surface with a nickel barrier. All multi-layer chip components are terminated with RoHS Compliant plating (see Addendum 2 below). Both of these plating types are forward and backwards compatible with standard soldering processes.

Labels indicating RoHS compliant status are included on component packaging. The RoHS compliant status will also appear on acknowledgements and invoices.

Addendum 1: Product discontinued: multi-layer devices with tin/lead plating. (Page 2, below.)

Addendum 2: New RoHS compliant plating for multi-layer chip components. (Page 3, below.)

For More Information Contact:

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Addendum 1: Product discontinued: multi-layer devices with tin/lead plating.

October 17, 2005

Valued Customers,

Since taking the first steps to comply with the RoHS Directive, Fair-Rite Products has maintained that it would continue to supply products with tin/lead termination as long as possible.

We have recently re-evaluated our position with regards to our "multi-layer chip" devices with tin/lead plating. This is due to a contamination problem, which continues to occur in the plating tanks when switching between the dominantly higher volume line of lead-free plated cores, and the low volume tin/lead plated products.

There is not a sufficient volume to justify separate equipment, and so effectively immediately, Fair-Rite Products will discontinue sales of multi-layer chip products with tin/lead termination. This decision affects the 25-product class Chip Beads and the 22- product class Chip Inductor part numbers ending with an L suffix.

We will continue filling existing orders until our current inventory of parts with tin/lead finish is depleted. At that point, we will regrettably be unable to take new orders for these parts.

Our present plans are to continue supplying tin/lead plating on all other board level components. They include the product families beginning with 27 and 29, and include Bead-on-leads, SM Beads, PC Beads and Wound Beads.

We sincerely regret any inconvenience this turn of events may cause.

Sincerely, Frank Babic
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Addendum 2: New RoHS compliant plating for multi-layer chip components.

As of 11/1/04, Fair-Rite Products Corp. has changed its RoHS compliant termination plating on all multi-layer chip beads and chip inductors from Sn-Ag-Cu to 100% tin over a nickel undercoating.

This compliant plating, which is also universally acceptable, has been used on our other components such as Beads on Leads and Surface Mount products since 2004, and will standardize a uniform termination plating on all of our board level products.

This is a seamless transition since the soldering profiles for both types of plating are similar. Also, since the termination composition does not affect product performance, no re-qualification is necessary.

We trust that this change will not cause any inconvenience.

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